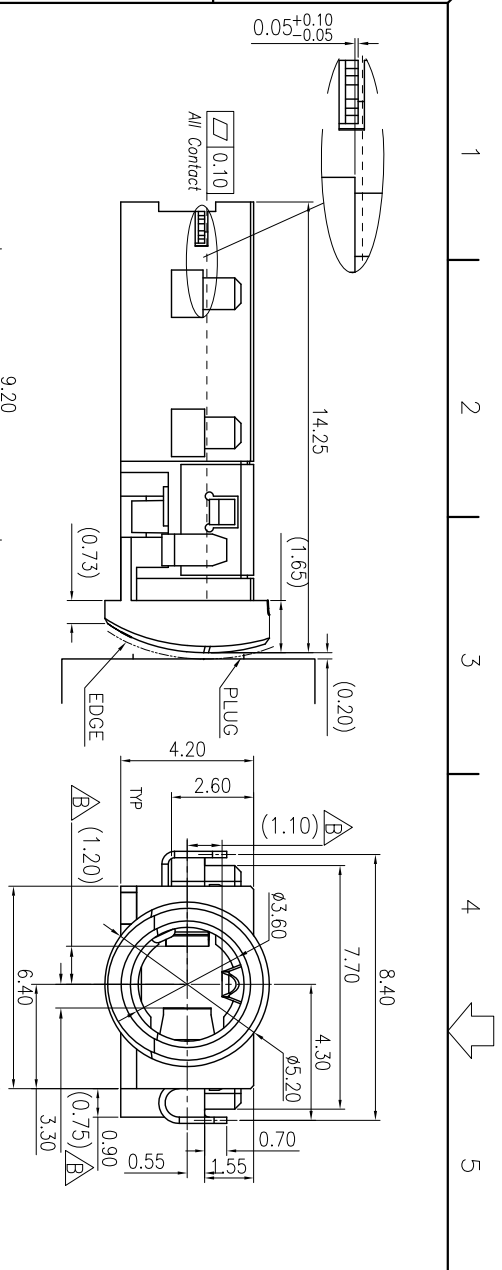
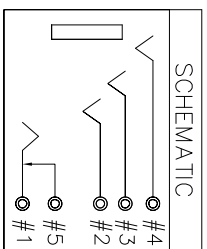
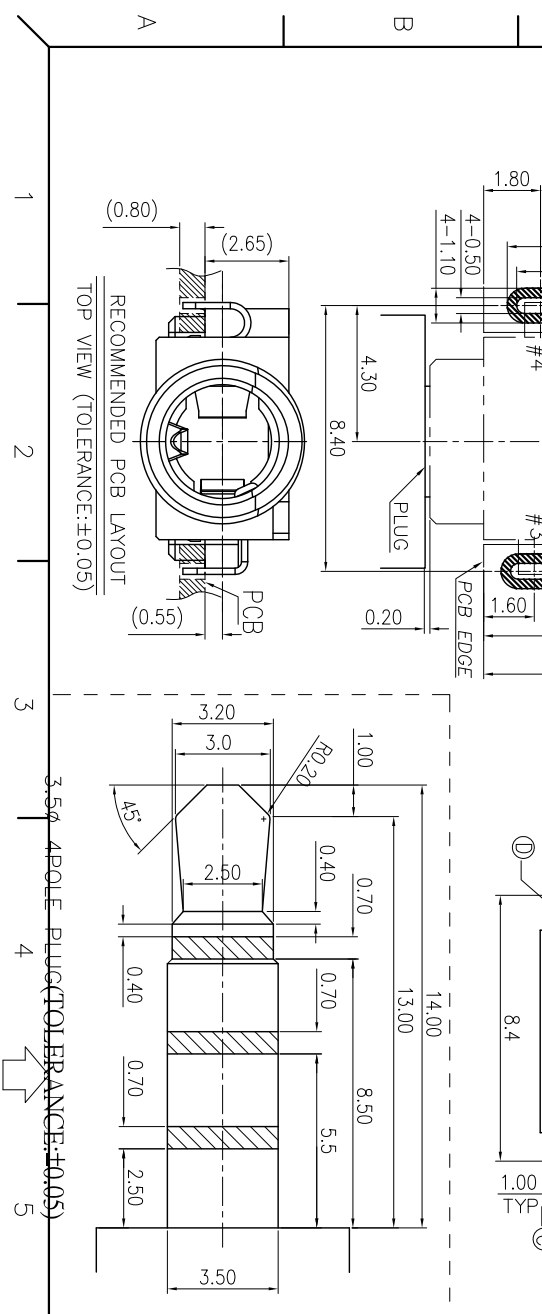


REV.	ECN NO.	OR DESCRIPTION	REVISED	DATE
A	PRODUCTS	RELEASE	Kim	2010.07.14
B	ECN NO:C100404	Add Dimension	LONGJIANG	2010.10.06
C	ECN:C110387	Modify plating	LONGJIANG	2012.01.03



- SPECIFICATIONS:**
- ELECTRICAL CHARACTERISTICS:**
    - 1-1. RATING: 12V AC, 1A DC.
    - 1-2. CONTACT RESISTANCE: 30mΩ MAX (INITIAL).
  - MECHANICAL CHARACTERISTICS:**
    - 2-1. INSERTION FORCE: 0.3~3.0 KGf
    - 2-2. WITHDRAWAL FORCE: 0.3~3.0 KGf
  - LIFE TEST: 10,000 CYCLES MIN.
  - PACKAGING: TAPE & REEL
  - TO CONFORM TO THE SINGATRON HSF SPECIFICATION.
  - HALOGEN FREE PRODUCT IDENTIFICATION MARK ON PRODUCT.
  - HALOGEN PRODUCT IDENTIFICATION LABEL ON PACKAGING.
  - FOR REFLOW SOLDERING LEAD-FREE PROCESS.
  - SOLDER HEAT RESISTANCE REFLOW SOLDERING 260°C 10SECS.
  - DATE CODE: YY MM DD



F	SHUNT A	1	COPPER ALLOY 0.2t	GOLD FLASH
E	BODY	1	HI-TEMP THERMOPLASTIC UL94V-0	BLACK COLOR
D	RING SPRING A	1	COPPER ALLOY 0.2t	GOLD FLASH
C	TIP SPRING	1	COPPER ALLOY 0.2t	Gold flash on contact area And solder tail call over Δ Nickel plated
B	RING SPRING B	1	COPPER ALLOY 0.2t	GOLD FLASH
A	EARTH	1	COPPER ALLOY 0.2t	GOLD FLASH
NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR

UNLESS OTHERWISE SPECIFIED TOLERANCES

DECIMALS: ANGLES:

X : ±0.5 X : ±2°  
 X.X : ±0.3 X.X : ±1°  
 X.XX : ±0.2

**CUSTOMER COPY**

Singatron Enterprise Co., Ltd.  
 信登企業股份有限公司

PART NO. 2512271-000221  
 SCALE 6:1 UNIT: mm  
 SHEET: 10F1 REV: C